NX3L1T53 Low-ohmic single-pole double-throw analog switch Rev. 8 – 23 January 2013 Product data sheet

1. General description

The NX3L1T53 is a low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2:1 multiplexer/demultiplexer. It has a digital select input (S), two independent inputs/outputs (Y0 and Y1), a common input/output (Z) and an active LOW enable input (\overline{E}). When pin \overline{E} is HIGH, the switch is turned off.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L1T53 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L1T53 allows signals with amplitude up to V_{CC} to be transmitted from Z to Y0 or Y1; or from Y0 or Y1 to Z. It's low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.6 Ω (typical) at V_{CC} = 1.4 V
 - 1.0 Ω (typical) at V_{CC} = 1.65 V
 - 0.55 Ω (typical) at V_{CC} = 2.3 V
 - 0.50 Ω (typical) at V_{CC} = 2.7 V
 - 0.50 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- 1.8 V control logic at $V_{CC} = 3.6$ V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

Table 1. Ordering information

Type number	Package	Package							
	Temperature range	Name	Description	Version					
NX3L1T53GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 \times 1.95 \times 0.5 mm	SOT833-1					
NX3L1T53GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm	SOT996-2					
NX3L1T53GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm	SOT902-2					

5. Marking

Table 2.Marking codes

Type number	Marking code
NX3L1T53GT	M53
NX3L1T53GD	M53
NX3L1T53GM	M53

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

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6. Functional diagram

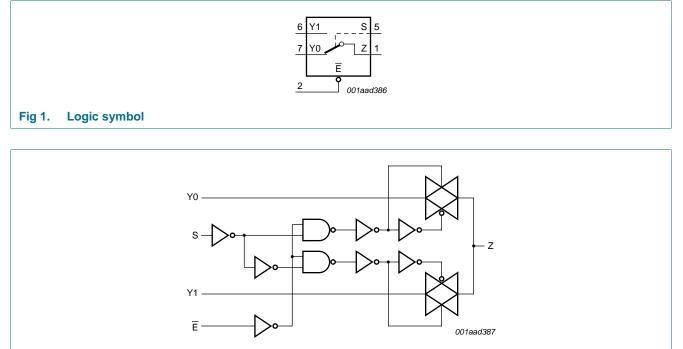
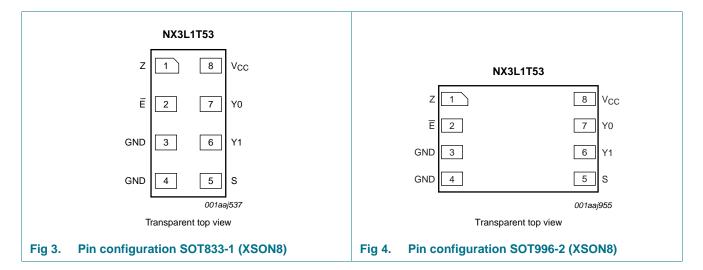


Fig 2. Logic diagram

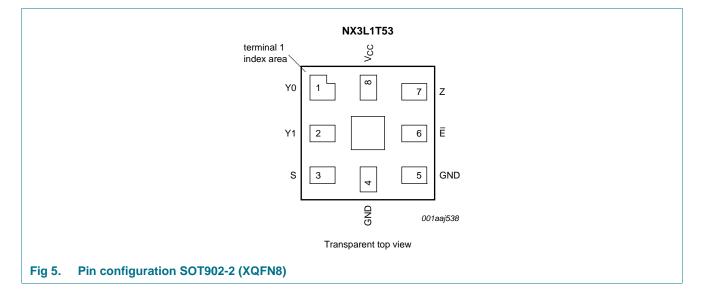
7. Pinning information

7.1 Pinning



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7.2 Pin description

Symbol	Pin		Description
	SOT833-1 and SOT996-2	SOT902-2	
Z	1	7	common output or input
Ē	2	6	enable input (active LOW)
GND	3	5	ground (0 V)
GND	4	4	ground (0 V)
S	5	3	select input
Y1	6	2	independent input or output
Y0	7	1	independent input or output
V _{CC}	8	8	supply voltage

8. Functional description

Table 4.Function table^[1]

Input	Input		
S	E		
L	L	Y0 to Z or Z to Y0	
Н	L	Y1 to Z or Z to Y1	
Х	Н	switch off	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

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9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	select input S and enable input \overline{E}	<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage		[2] -0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	V_{l} < -0.5 V or V_{l} > V_{CC} + 0.5 V	-	±50	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current	-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3] _	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XSON8 and XQFN8 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CC}	supply voltage			1.4	-	4.3	V
VI	input voltage	select input S and enable input \overline{E}		0	-	4.3	V
V _{SW}	switch voltage		<u>[1]</u>	0	-	V _{CC}	V
T _{amb}	ambient temperature			-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.4 V to 4.3 V	[2]	-	-	200	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

11. Static characteristics

Table 7. Static characteristics

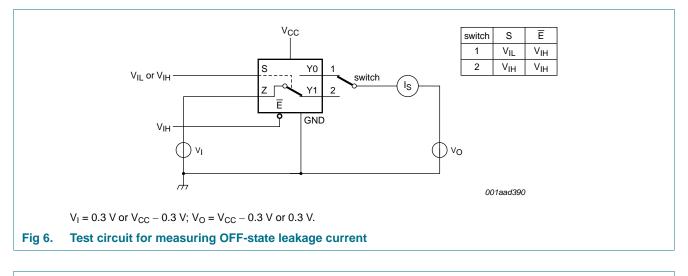
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

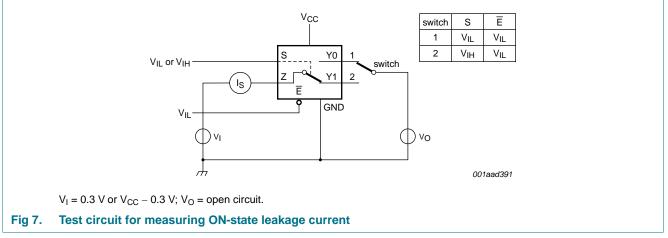
Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V _{IH}	HIGH-level	V _{CC} = 1.4 V to 1.6 V	0.9	-	-	0.9	-	-	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	0.9	-	-	0.9	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		V_{CC} = 2.7 V to 3.6 V	1.3	-	-	1.3	-	-	V
		V_{CC} = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	V
V _{IL}	LOW-level	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	-	0.3	-	0.3	0.3	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	0.4	-	0.4	0.3	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
I	input leakage current	select input S and enable input \overline{E} ; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μΑ
$I_{S(OFF)}$	OFF-state leakage	Y0 and Y1 port; see <u>Figure 6</u>							
	current	V_{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		V_{CC} = 3.6 V to 4.3 V	-	-	±10	-	±50	±500	nA
I _{S(ON)}	ON-state	Z port; see Figure 7							
	leakage	V_{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
	current	V_{CC} = 3.6 V to 4.3 V	-	-	±10	-	±50	±500	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC}							
		$V_{CC} = 3.6 V$	-	-	100	-	690	6000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	7000	nA
ΔI_{CC}	additional	V_{SW} = GND or V_{CC}							
	supply current	$V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μA
		$V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	0.35	0.7	-	1	1	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	7.0	10.0	-	15	15	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	2.5	4.0	-	5	5	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$	-	50	200	-	300	500	nA
CI	input capacitance		-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	130	-	-	-	-	pF

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11.1 Test circuits





11.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

		-						
Symbol	Parameter	Conditions	-40	-40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max]
R _{ON(peak)}	ON resistance (peak)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$; see <u>Figure 8</u>						
		V _{CC} = 1.4 V	-	1.6	3.7	-	4.1	Ω
		V _{CC} = 1.65 V	-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 V$	-	0.55	0.8	-	0.9	Ω
		V _{CC} = 2.7 V	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω

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At recomn	At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see <u>Figure 9</u> to <u>Figure 15</u> .									
Symbol	Parameter	Conditions	-40	–40 °C to +85 °C		–40 °C to	o +125 °C	Unit		
			Min	Typ[1]	Max	Min	Max			
ΔR_{ON}	ON resistance mismatch between channels	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$						•		
		$V_{CC} = 1.4 V$	-	0.04	0.3	-	0.3	Ω		
		V _{CC} = 1.65 V	-	0.04	0.2	-	0.3	Ω		
		$V_{CC} = 2.3 V$	-	0.02	0.08	-	0.1	Ω		
		$V_{CC} = 2.7 V$	-	0.02	0.075	-	0.1	Ω		
		$V_{CC} = 4.3 V$	-	0.02	0.075	-	0.1	Ω		
R _{ON(flat)}	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	<u>l</u>							
		$V_{CC} = 1.4 V$	-	1.0	3.3	-	3.6	Ω		
		V _{CC} = 1.65 V	-	0.5	1.2	-	1.3	Ω		
		$V_{CC} = 2.3 V$	-	0.15	0.3	-	0.35	Ω		
		$V_{CC} = 2.7 V$	-	0.13	0.3	-	0.35	Ω		
		$V_{CC} = 4.3 V$	-	0.2	0.4	-	0.45	Ω		

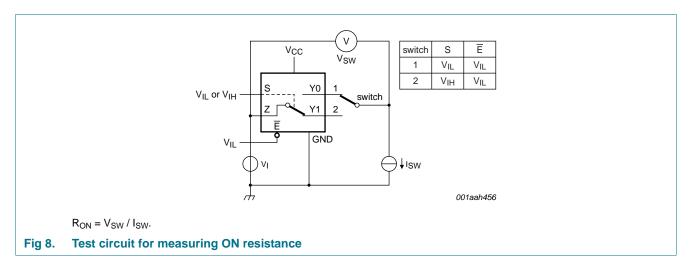
Table 8. **ON resistance** ...continued

[1] Typical values are measured at T_{amb} = 25 °C.

Measured at identical V_{CC}, temperature and input voltage. [2]

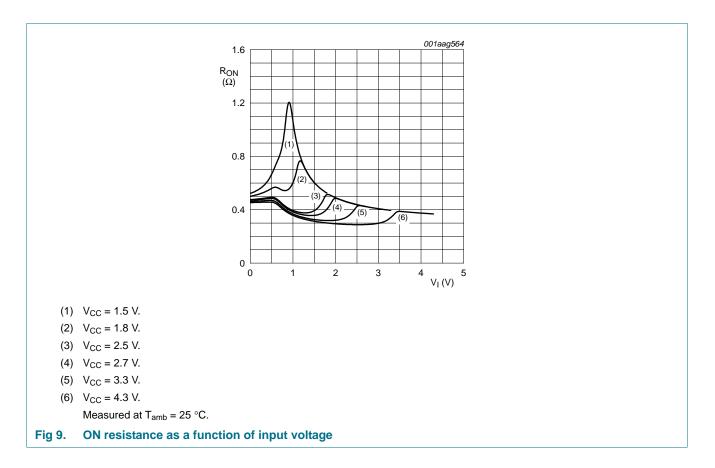
Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and [3] temperature.

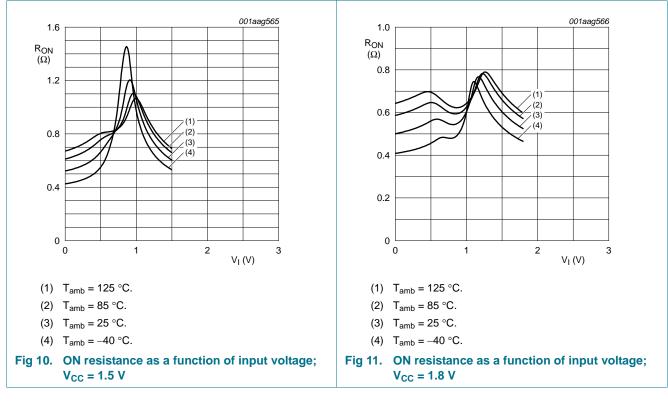
11.3 ON resistance test circuit and waveforms



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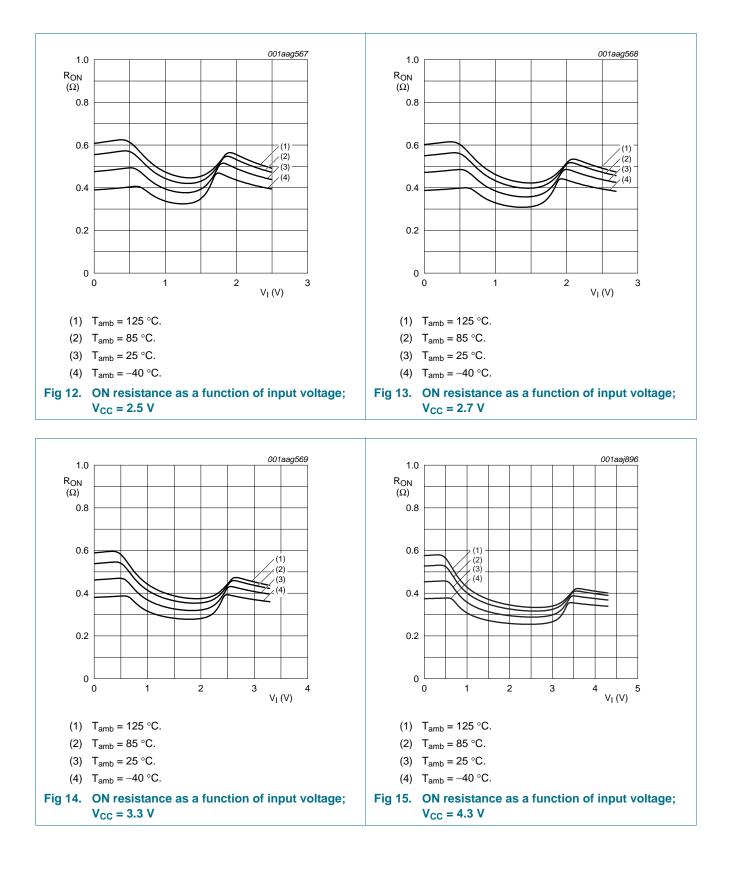




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12. Dynamic characteristics

Table 9. Dynamic characteristics

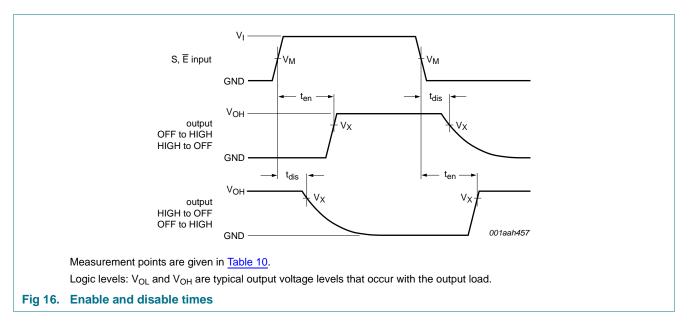
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 18.

Symbol	Parameter	Conditions		25 °C		-40) °C to +12	5 °C	Unit
			Min	Typ[1]	Мах	Min	Max (85 °C)	Max (125 °C)	
t _{en}	enable time	S or Ē to Z or Yn; see <u>Figure 16</u>							
		V_{CC} = 1.4 V to 1.6 V	-	50	90	-	120	120	ns
		V _{CC} = 1.65 V to 1.95 V	-	36	70	-	80	90	ns
		V_{CC} = 2.3 V to 2.7 V	-	24	45	-	50	55	ns
		V_{CC} = 2.7 V to 3.6 V	-	22	40	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V	-	22	40	-	45	50	ns
t _{dis}	disable time	S or E to Z or Yn; see <u>Figure 16</u>							
		V_{CC} = 1.4 V to 1.6 V	-	32	70	-	80	90	ns
		V_{CC} = 1.65 V to 1.95 V	-	20	55	-	60	65	ns
		V_{CC} = 2.3 V to 2.7 V	-	12	25	-	30	35	ns
		V_{CC} = 2.7 V to 3.6 V	-	10	20	-	25	30	ns
		V_{CC} = 3.6 V to 4.3 V	-	10	20	-	25	30	ns
t _{b-m}	break-before-make	see Figure 17	<u>2]</u>						
	time	V_{CC} = 1.4 V to 1.6 V	-	19	-	9	-	-	ns
		V_{CC} = 1.65 V to 1.95 V	-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V	-	13	-	4	-	-	ns
		V_{CC} = 2.7 V to 3.6 V	-	10	-	3	-	-	ns
		V_{CC} = 3.6 V to 4.3 V	-	10	-	2	-	-	ns

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

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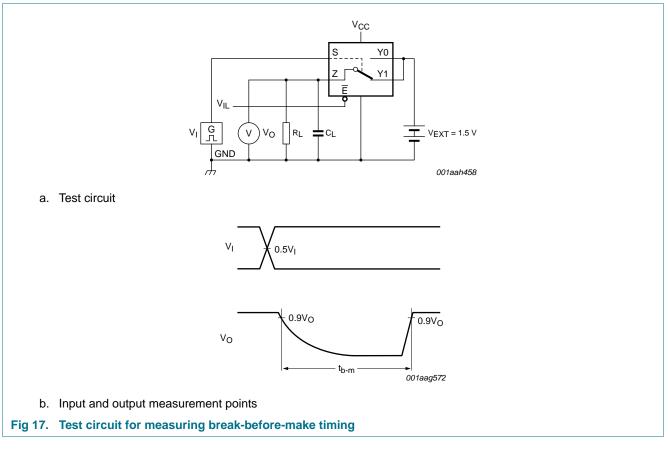
12.1 Waveform and test circuits

Table 10. Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	Vx
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}

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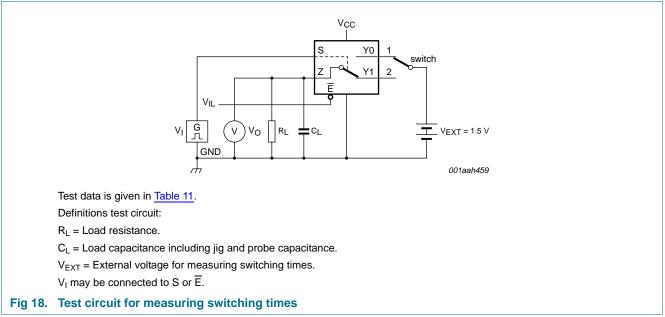


Table 11.Test data

Supply voltage	Input		Load		
V _{cc}	V _I t _r , t _f (CL	RL	
1.4 V to 4.3 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω	

12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

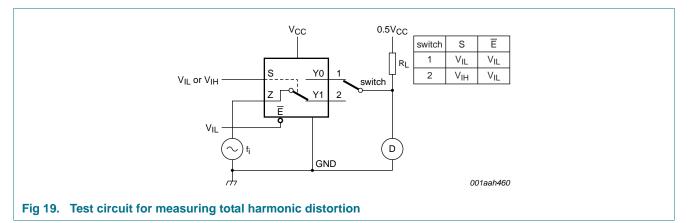
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

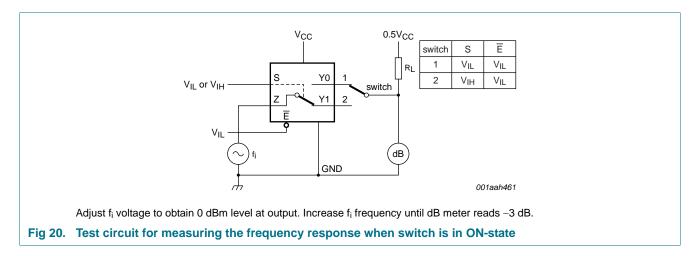
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
THD	total harmonic distortion	$f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 19}{1000 \text{ sec } 19}$	<u>[1]</u>				
		V _{CC} = 1.4 V; V _I = 1 V (p-p)		-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)		-	0.10	-	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)		-	0.02	-	%
		$V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = 2 \text{ V} (p-p)$		-	0.02	-	%
		$V_{CC} = 4.3 \text{ V}; \text{ V}_{I} = 2 \text{ V} (p-p)$		-	0.02	-	%
f _(-3dB)	–3 dB frequency response	$R_L = 50 \Omega$; see Figure 20	<u>[1]</u>				
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		-	60	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}; \text{ R}_L = 50 \Omega; \text{ see } \frac{\text{Figure 21}}{100 \text{ kHz}}$	<u>[1]</u>				
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 22					
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$		-	0.2	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$		-	0.3	-	V
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz; } R_L = 50 \Omega$; see Figure 23	<u>[1]</u>				
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		-	-90	-	dB
Q _{inj}	charge injection	$f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega;$ see <u>Figure 24</u>					
		$V_{CC} = 1.5 V$		-	3	-	рС
		V _{CC} = 1.8 V		-	4	-	рС
		$V_{CC} = 2.5 V$		-	6	-	рС
		$V_{CC} = 3.3 V$		-	9	-	рС
		$V_{CC} = 4.3 V$		-	15	-	рС

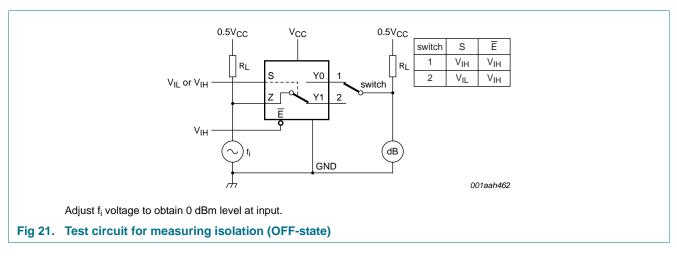
[1] f_i is biased at 0.5V_{CC}.

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12.3 Test circuits



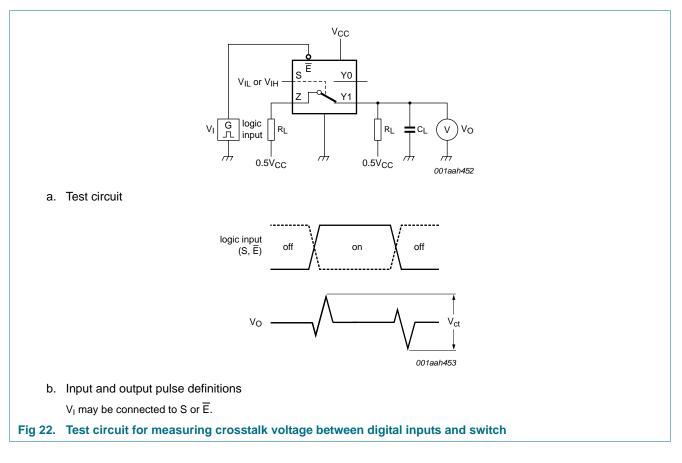


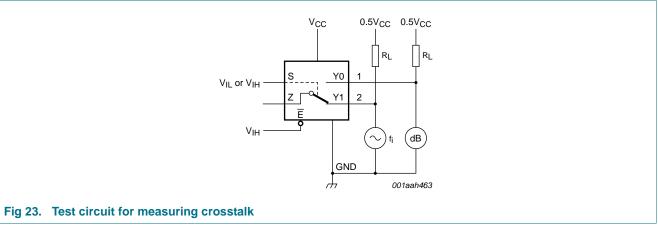


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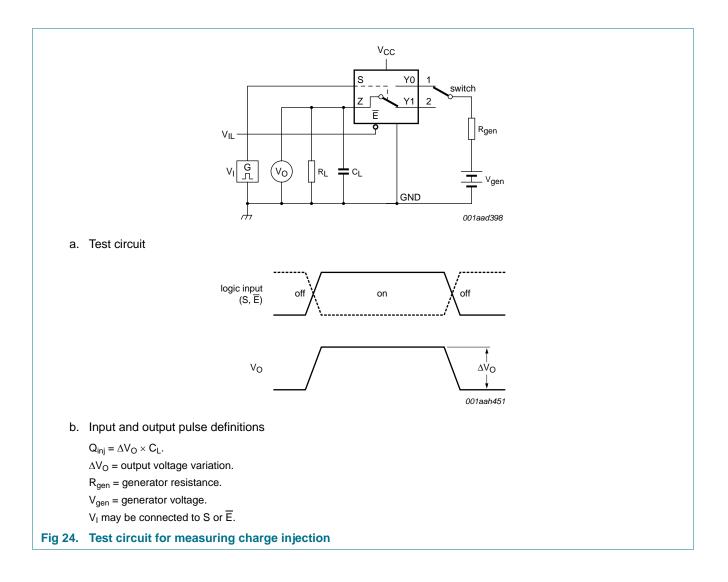
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13. Package outline

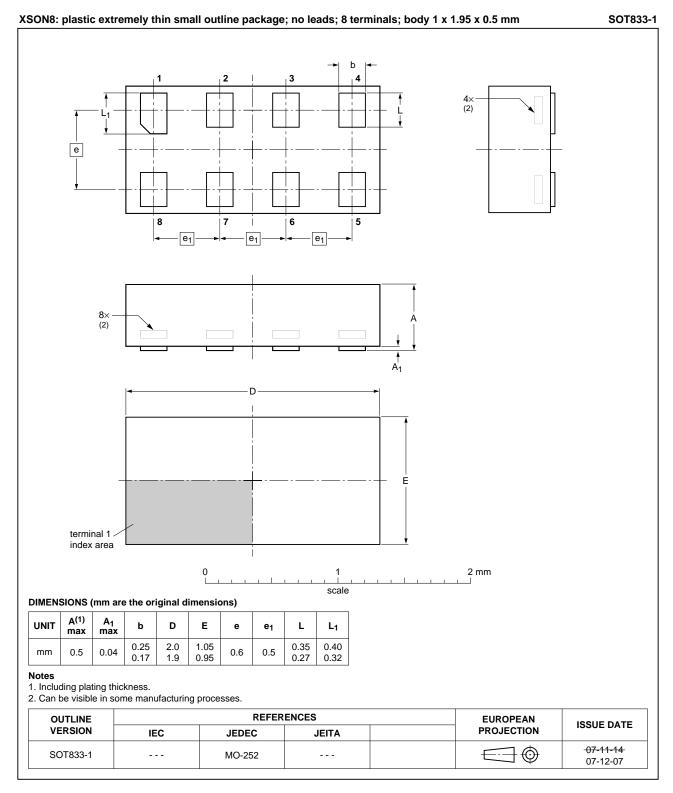
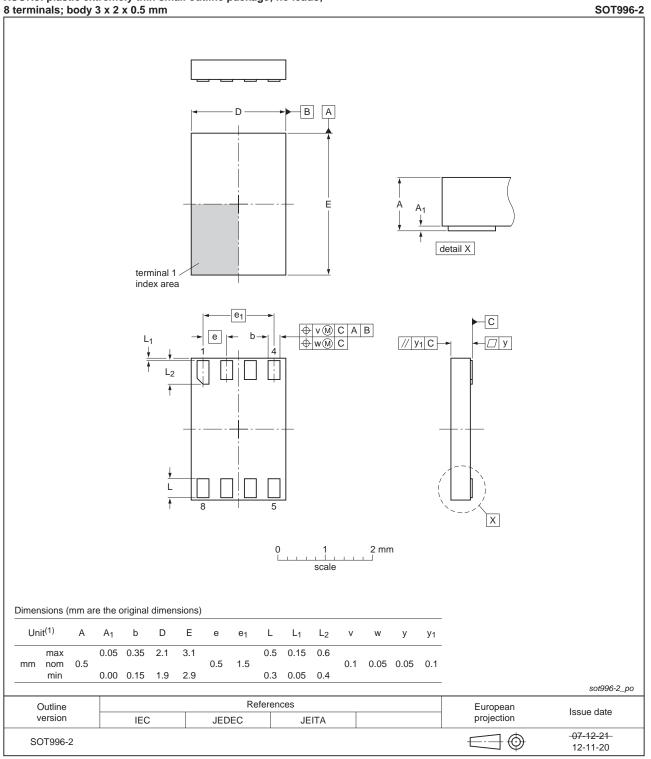


Fig 25. Package outline SOT833-1 (XSON8)

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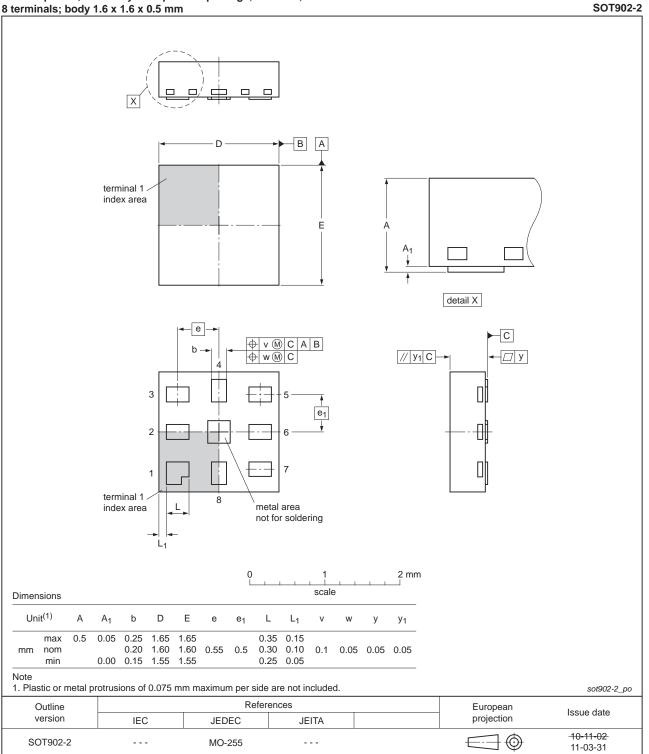


XSON8: plastic extremely thin small outline package; no leads;

Fig 26. Package outline SOT996-2 (XSON8)

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XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm

Fig 27. Package outline SOT902-2 (XQFN8)

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14. Abbreviations

AcronymDescriptionCDMCharged Device ModelCMOSComplementary Metal-Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body ModelMMMachine Model	Table 13. Abbreviations					
CMOSComplementary Metal-Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body Model	Acronym	Description				
ESD ElectroStatic Discharge HBM Human Body Model	CDM	Charged Device Model				
HBM Human Body Model	CMOS	Complementary Metal-Oxide Semiconductor				
	ESD	ElectroStatic Discharge				
MM Machine Model	HBM	Human Body Model				
	MM	Machine Model				

15. Revision history

Table 14. Revision history **Document ID Release date** Data sheet status **Change notice** Supersedes NX3L1T53 v.8 20130123 Product data sheet NX3L1T53 v.7 Modifications: For type number NX3L1T53GD XSON8U has changed to XSON8. NX3L1T53 v.6 NX3L1T53 v.7 20120613 Product data sheet -NX3L1T53 v.6 20111108 Product data sheet NX3L1T53 v.5 -NX3L1T53 v.5 20110801 Product data sheet NX3L1T53 v.4 -NX3L1T53 v.4 20100324 Product data sheet NX3L1T53 v.3 -NX3L1T53 v.3 20100201 Product data sheet NX3L1T53 v.2 _ NX3L1T53 v.2 20090414 Product data sheet NX3L1T53 v.1 -NX3L1T53 v.1 20090217 Product data sheet --

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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